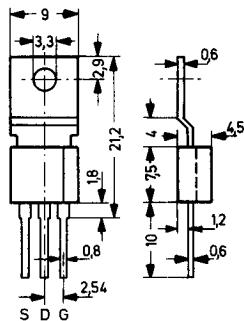


# BD512

**Enhancement Mode P-Channel Power VMOS Transistor**  
for applications needing high input impedance  
and fast switching times.

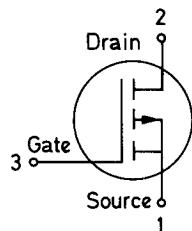
## Features:

- High input impedance
- High speed switching
- No minority carrier storage time
- CMOS logic compatible input
- No thermal runaway
- No secondary breakdown
- Paralleling is simple
- Heat sink connected to drain



Plastic case TO-202  
(34 A 3, DIN 41 869)

Weight approximately 1.5 g  
Dimensions in mm



## Graphic Symbol

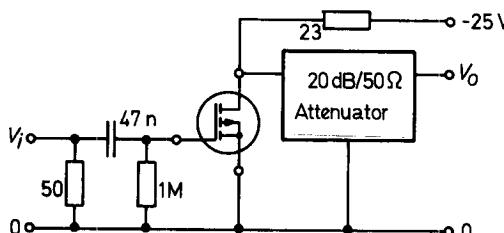
## Absolute Maximum Ratings

	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	-60	V
Drain-Gate Voltage	$V_{DGS}$	-60	V
Continuous Drain Current	$I_D$	-1.5	A
Power Dissipation at 25 °C Case Temperature at 25 °C Free Air Temperature	$P_{tot}$ $P_{tot}$	10 1.75	W W
Temperature (Operating and Storage)	$T_j, T_s$	-55 to +150	°C

Characteristics at  $T_j = 25^\circ\text{C}$ 

	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage at $V_{GS} = 0, -I_D = 100 \mu\text{A}$	$-V_{(BR)DSS}$	60	80	—	V
Gate Threshold Voltage at $V_{GS} = V_{DS}, -I_D = 1 \text{ mA}$	$-V_{GS(\text{th})}$	1.0	—	3.5	V
Gate-Body Leakage Current at $-V_{GS} = 15 \text{ V}, V_{DS} = 0$	$-I_{GSS}$	—	—	100	nA
Drain Cutoff Current at $V_{GS} = 0, -V_{DS} = 25 \text{ V}$	$-I_{D(\text{off})}$	—	—	0.5	$\mu\text{A}$
Drain-Source On Resistance <sup>1)</sup> at $-V_{GS} = 10 \text{ V}, -I_D = 1 \text{ A}$	$r_{DS(\text{on})}$	—	4.5	7	$\Omega$
Thermal Resistance Chip to Heat Sink Chip to Ambient	$R_{thS}$ $R_{thA}$	—	—	12.5 70	K/W K/W
Forward Transconductance <sup>1)</sup> at $-V_{DS} = 10 \text{ V}, -I_D = 0.5 \text{ A}, f = 1 \text{ MHz}$	$g_m$	—	300	—	$\text{mS}$
Input Capacitance at $V_{GS} = 0, -V_{DS} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{iss}$	—	140	—	$\text{pF}$
Turn On Time Turn Off Time	$t_{on}$ $t_{off}$	—	4	10	ns ns

<sup>1)</sup> Pulse Test Width  $-80 \mu\text{s}$ ; Pulse Duty Factor 1%.



Test Circuit for the Switching Times

